

### Technical Data Sheet Infrared MIDLED LED EAIST3122A0



#### Features

- Low forward voltage.
- View angle 30° (Typ.)
- Pb free
- The product itself will remain within RoHS compliant version
- Compatible with infrared and vapor phase reflow solder process
- Taping as Top view.

#### Description

- EAIST3122A0 is an infrared emitting diode with miniature MIDLED package. The device is spectrally matched with silicon photodiode and phototransistor.

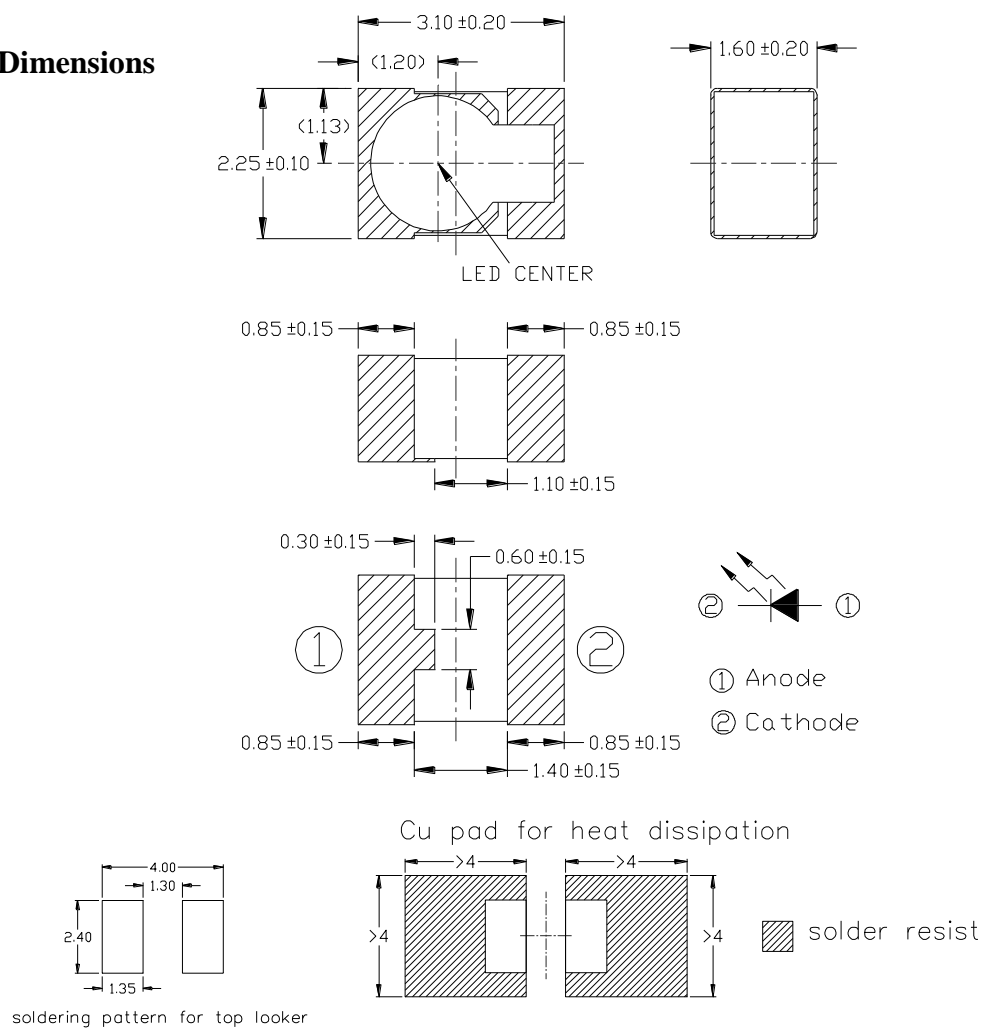
#### Applications

- Infrared applied system

#### Device Selection Guide

Device No.	Chip Material	Lens Color
EAIST3122A0	GaAlAs	Water clear

## Package Dimensions



- Notes:** 1.All dimensions are in millimeters  
2.Tolerances unless dimensions  $\pm 0.1\text{mm}$

## Absolute Maximum Ratings ( $T_a=25^\circ\text{C}$ )

Parameter	Symbol	Rating	Unit
Continuous Forward Current	$I_F$	65	mA
Peak Forward Current *1	$I_{FP}$	200	mA
Reverse Voltage	$V_R$	5	V
Operating Temperature	$T_{opr}$	$-40 \sim +85$	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	$-40 \sim +100$	$^\circ\text{C}$
Soldering Temperature *2	$T_{sol}$	260	$^\circ\text{C}$
Power Dissipation at(or below) 25 $^\circ\text{C}$ Free Air Temperature	$P_d$	100	mW

**Notes:** \*1:  $I_{FP}$  Conditions--Pulse Width  $\leq 500\mu\text{s}$  and Duty  $\leq 5\%$ .

\*2: Soldering time  $\leq 5$  seconds.

**Electro-Optical Characteristics (Ta=25°C)**

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Radiant Intensity	I <sub>e</sub>	40	--	125	mW/sr	I <sub>F</sub> =70mA ,tp=20ms
Peak Wavelength	λ <sub>p</sub>	--	850	--	nm	I <sub>F</sub> =100mA
Spectral Bandwidth	Δλ	--	30	--	nm	I <sub>F</sub> =100mA
Forward Voltage	V <sub>F</sub>	--	1.40	1.70	V	I <sub>F</sub> =20mA
		--	1.55	1.90		I <sub>F</sub> =70mA, tp=20ms
Reverse Current	I <sub>R</sub>	--	--	10	μA	V <sub>R</sub> =5V
View Angle	2θ <sub>1/2</sub>	--	30	--	deg	I <sub>F</sub> =20mA

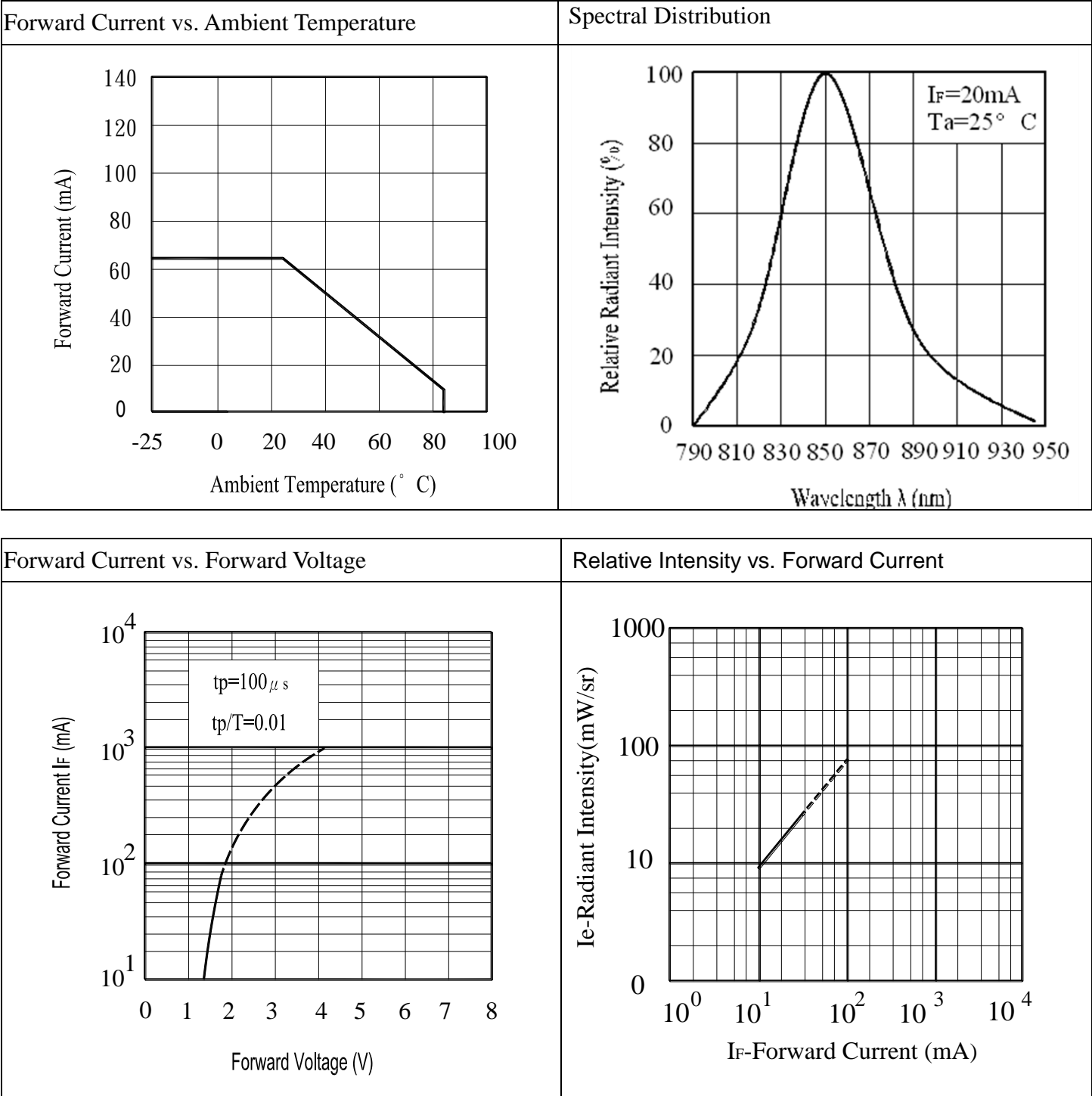
**Rank**

Condition : I<sub>F</sub>=70mA

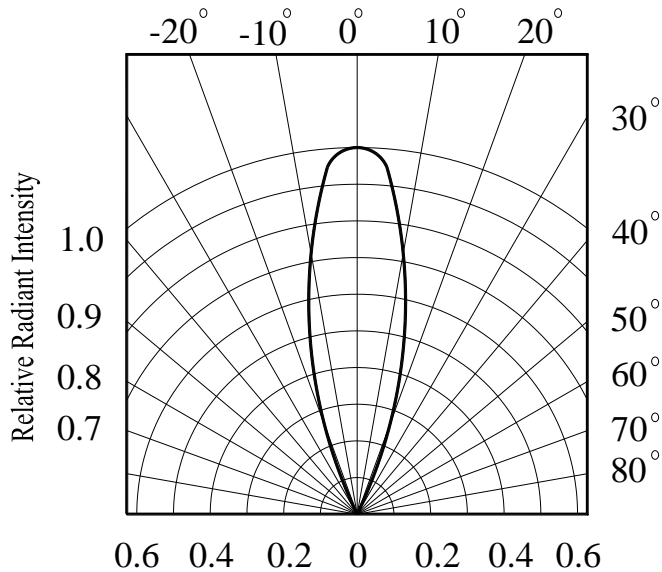
Unit : mW/sr

Bin Number	C	D
Min	40	63
Max	80	125

Typical Electrical/Optical/Characteristics Curves



Relative Radiant Intensity vs. Angular Displacement



## ● Precautions For Use

### 1. Over-current-proof

Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change ( Burn out will happen ).

### 2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.

2.3 The LEDs should be used within a year.

2.4 After opening the package, the LEDs should be kept at 30°C or less and 60%RH or less.

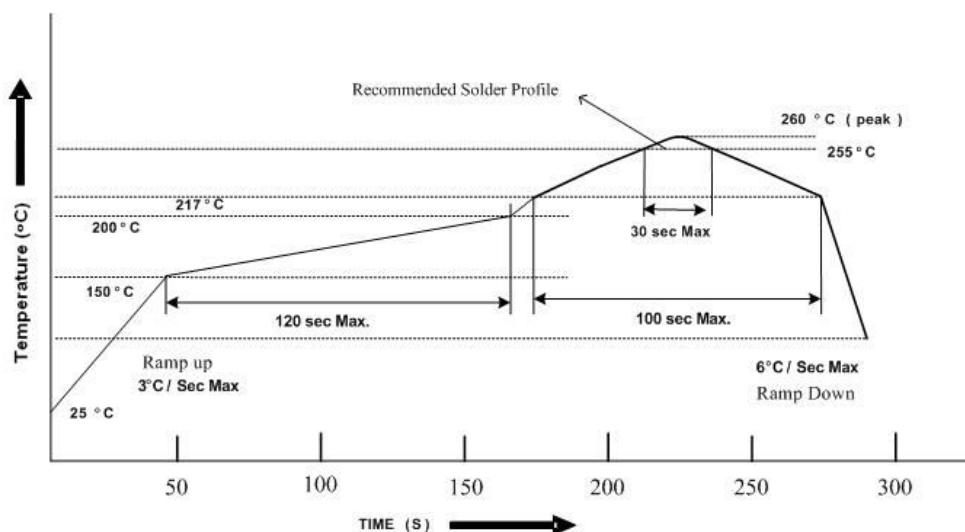
2.5 The LEDs should be used within 168 hours (7 days) after opening the package

2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60±5°C for Min. 24 hours.

### 3. Soldering Condition

#### 3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

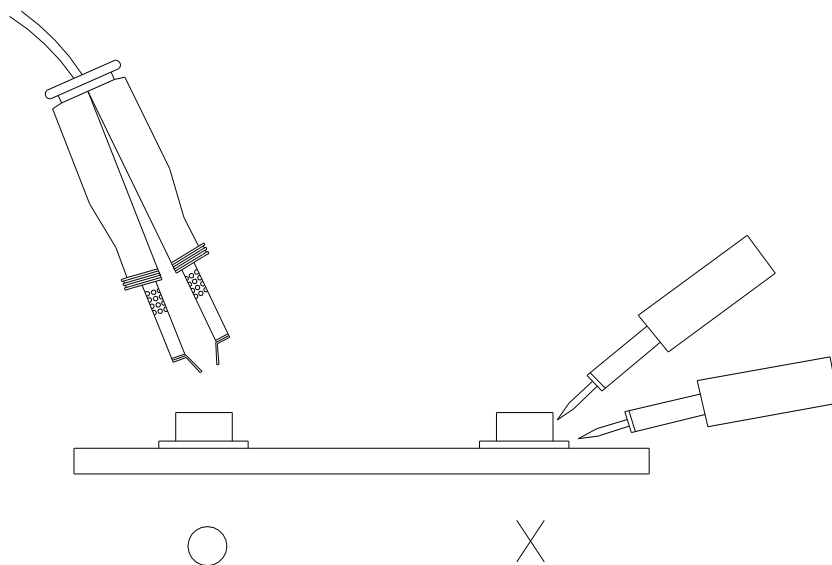
3.4 After soldering, do not warp the circuit board.

#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

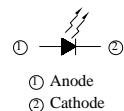


Technical drawing of a circular component, likely a flange or end plate, showing dimensions in millimeters (mm).

The drawing includes the following dimensions:

- Overall diameter:  $\phi 178.0 \pm 1.0$
- Inner diameter (hole):  $\phi 60.0 \pm 0.5$
- Distance from center to the start of the outer flange:  $2.2 \pm 0.5$
- Distance from center to the start of the inner flange:  $\phi 13.0 \pm 0.5$
- Thickness of the outer flange:  $9.0 \pm 0.5$
- Thickness of the inner flange:  $12.0 \pm 0.15$

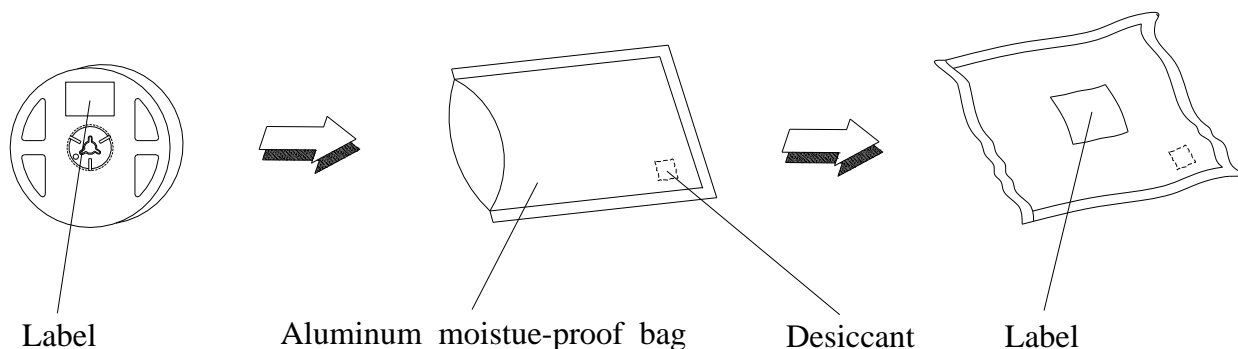
## 2. Carrier Tape Dimensions:(Quantity: 2000pcs/reel)



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## Packing Procedure



## Label Form Specification

	<b>EVERLIGHT AMERICA</b>	
CPN: XXXXXXXXXXXX		
P/N: XXXXXXXXXXXX		
		<b>RoHS</b>
XXXXXXXXXXXXXXXXXXXX		
QTY: XXXX	CAT: XXX	
	HUE: XXX	
	REF: XXX	
LOT NO: XXXXXXXXXXXXXXXXXXXX		
REFERENCE: XXXXXXXXXXXX		
<b>MADE IN TAIWAN</b>		

CPN: Customer's Production Number  
P/N : Production Number  
QTY: Packing Quantity  
CAT: Ranks  
HUE: Peak Wavelength  
REF: Reference  
LOT No: Lot Number  
MADE IN TAIWAN: Production Place

## Notes

1. Above specification may be changed without notice. Everlight Americas will reserve authority on material change for above specification.
2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. Everlight Americas assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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